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RECORDATION FORM COVER SHEET

U.S. DEPARTMENT OF CO	MN
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SON-2075	PATENTS ONLY	Patent and Trademark Office	
To the Honorable Commissioner of Patents and Trademark	ks: Please record the attached origi	nal documents or copy thereof.	2
1. Name of conveying party(ies)		s of receiving party(ies)	3
1. Takao FURUSATO 2. Hiroaki ICHIKAWA	Name: SONY COR	PORATION	
Additional name(s) of conveying party(ies) attached No.			
3. Nature of conveyance: 4-24-0[KITASHINAGAWA 6-CHOME NAGAWA-KU	
☑ Assignment ☐ Merger	City: TOKYO, JAP	AN	
☐ Security Agreement ☐ Change of Name	Additional name(s) &	k address(es) attached ☐ Yes ☒ No	
Execution Date: March 29, 2001			
4. Application number(s) or patent number(s):		09/840275	
If the document is being filed together with a new appl	ication, the execution date of the ap	plication March 29, 2001	*
5. Name and address of party to whom correspondence co- document should be mailed:	oncerning 6. Total number of a	applications and patents involved: 1	
Name: Ronald P. Kananen, Esq.	7. Total fee (37 CFI	R 3.41) \$ 40.00	
Internal Address: RADER, FISHMAN & GRAUER	Enclosed		
Suite 501	⊠Authorized to l	be charged to Deposit Account	
Street Address: 1233 20th Street, NW	8. Deposit account r	number:	
City: Washington, D.C. Zip: 20036	(Attach duplicate	18-0013 copy of this page if paying by deposit acc	ount)
DO NOT USE THIS SPACE			
9. Statement and signature. To the best of my knowledge and belief, the foregoing, document.	information is true and correct and		iginal
Ronald P. Kananen Name of Person Signing	Signature	<u>April 24, 2001</u> Date	
Total number of pages comprising cover sheet 1	1.1	4100	E

PATENT REEL: 011736 FRAME: 0239

Docket Number: SON-	-2075
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ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in ACTIVE MATRIX CIRCUIT, METHOD OF DRIVING THE SAME, AND SURFACE PRESSURE DISTRIBUTION DETECTING APPARATUS for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address; AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chome, Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention. said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries; NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto; And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto; And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense; And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto; And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale. And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: ______, Filing Date:______, This assignment executed on the dates indicated below. March 29. 200/ Execution date of U.S. Patent Application TAKAO FURUSATO Name of first or sole inventor KANAGAWA, JAPAN Residence of first or sole inventor March 29 . 200/ TALAC FURVANTO
Signature of first or sole inventor

> PATENT REEL: 011736 FRAME: 0240

HIROAKI ICHIKAWA	May 21 29 2001
Name of second inventor KANAGAWA, JAPAN	Execution date of U.S. Patent Application
Residence of second inventor Nirochi Molukyun	Planch 2°/, 2cv/ Date of this assignment
Signature of second inventor	Date of this assignment
Name of third inventor	Execution date of U.S. Patent Application
Residence of third inventor	
Signature of third inventor	Date of this assignment
Name of fourth inventor	Execution date of U.S. Patent Application
Residence of fourth inventor	
Signature of fourth inventor	Date of this assignment
Name of fifth inventor	Execution date of U.S. Patent Application
	Zacoulon date of old, I atom / application
Residence of fifth inventor	
Signature of fifth inventor	Date of this assignment

PATENT
RECORDED: 04/24/2001 REEL: 011736 FRAME: 0241